

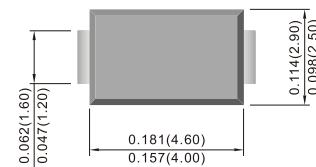


## Surface Mount Schottky Rectifier

### Features

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

DO-214AC (SMA)

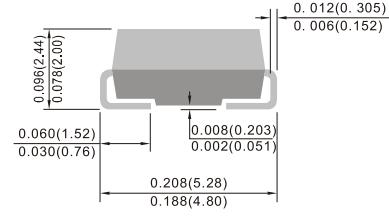


### Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### Mechanical Data

- **Package:** DO-214AC (SMA)  
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end



Unit : inch(mm)

### ■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS								
			52A	53A	54A	55A	56A	58A	510A	515A	520A
Repetitive peak reverse voltage	V <sub>RRM</sub>	V	20	30	40	50	60	80	100	150	200
Average rectified output current @60Hz sine wave, resistance load, TL (FIG.1)	I <sub>O</sub>	A									5.0
Surge(non-repetitive)forward current @ 60Hz half-sine wave, 1 cycle, Ta=25°C	I <sub>FSM</sub>	A									150
Storage temperature	T <sub>stg</sub>	°C									-55 ~+150
Junction temperature	T <sub>j</sub>	°C									-55 ~+175

### ■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	SS							
				52A	53A	54A	55A	56A	58A	510A	515A
Maximum instantaneous forward voltage drop per diode	V <sub>F</sub>	V	I <sub>FM</sub> =5.0A	0.55	0.70	0.85	0.95				
Maximum DC reverse current at rated DC blocking voltage per diode@ V <sub>RM</sub> =V <sub>RRM</sub>	I <sub>RRM</sub>	mA	Ta=25°C	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.1
			Ta=100°C	10	10	10	10	10	10	10	5

### ■Thermal Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS								
			52A	53A	54A	55A	56A	58A	510A	515A	520A
Thermal resistance	R <sub>θJ-A</sub>	°C/W	60 <sup>1)</sup>								
	R <sub>θJ-L</sub>		22 <sup>1)</sup>								

Note

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas



## ■ Characteristics (Typical)

FIG1: Io-TL Curve

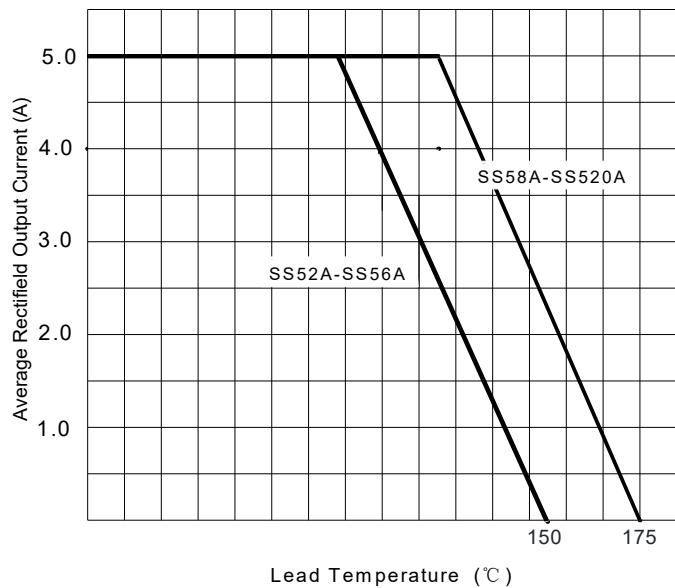


FIG2: Surge Forward Current Capability

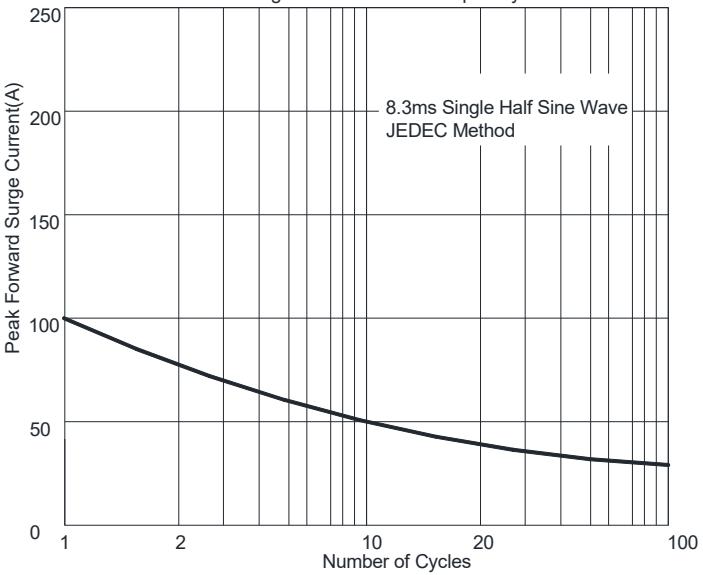


FIG3: TYPICAL FORWARD CHARACTERISTICS

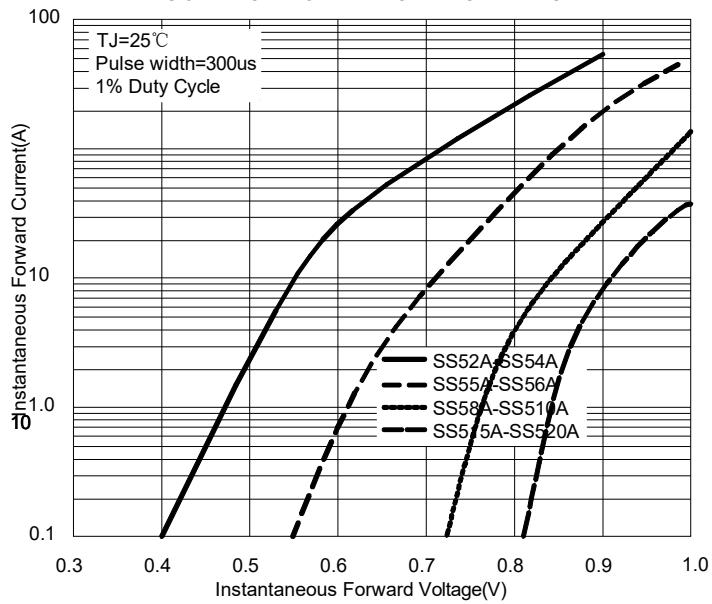


FIG4: Typical Reverse Characteristics

